Power MOSFETs

Unit: mm

2SK3277

Silicon N-channel power MOSFET



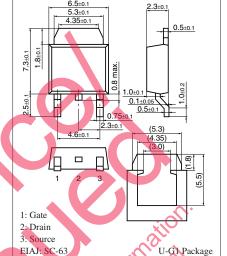
- Avalanche energy capability guaranteed
- High-speed switching
- No secondary breakdown

Applications

- Non-contact relay
- Solenoid drive
- Motor drive
- Control equipment
- Switching mode regulator

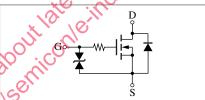
Absolute Maximum Ratings $T_C = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Drain-source surrender voltage	V _{DSS}	200	V
Gate-source surrender voltage	V _{GSS}	±20	V
Drain current	ID	±2.5	A
Peak drain current	I _{DP}	±5	A
Avalanche energy capability *	EAS	15	mJ
Power dissipation	PD	10	W
$T_a = 25^{\circ}C$		1	
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C



Marking Symbol: K3277

Internal Connection

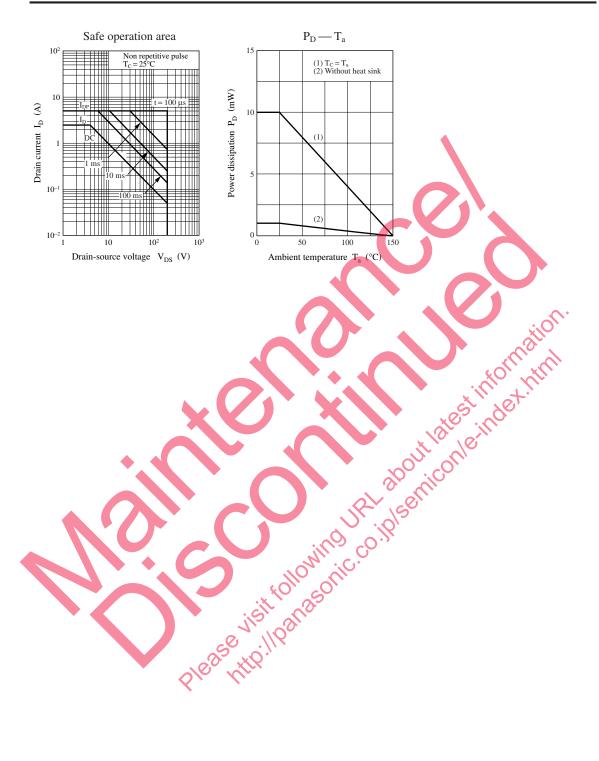


Note) *: L = 5 mH, I_L = 2.5 A, 1 pulse

Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source surrender voltage	V _{DSS}	$I_D = 1 \text{ mA}, V_{GS} = 0$	200			V
Drain-source cutoff current	I _{DSS}	$V_{\rm DS} = 160 {\rm V}, {\rm V}_{\rm GS} = 0$			10	μΑ
Gate-source cutoff current	I _{GSS}	$V_{GS} = \pm 20 \text{ V} \text{ V}_{DS} = 0$			±10	μΑ
Gate threshold voltage	V _{th}	$V_{\rm DS} = 25 X, I_{\rm D} = 1 {\rm mA}$	2.0		4.0	V
Drain-source ON resistance	R _{DS(on)}	$V_{GS} = 10$ V, $I_D = 1.25$ A		1.2	1.7	Ω
Forward transfer admittance	Y _{fs}	$V_{DS} = 25 \text{ V}, \text{ I}_{\text{D}} = 1.25 \text{ A}$	0.7	1.3		S
Diode forward voltage	DF	$I_{DR} = 2.5 \text{ A}, V_{GS} = 0$			-1.4	V
Short-circuit forward transfer capacitant (Common source)	C _{iss}	$V_{DS} = 20 V, V_{GS} = 0, f = 1 MHz$		170		pF
Short-circuit output capacitance (Common source)	C _{oss}	-		25		pF
Reverse transfer capacitance (Common source)	C _{rss}			15		pF
Turn-on delay time	t _{d(on)}	$V_{DD} = 100 \text{ V}, I_D = 1 \text{ A}, R_L = 100 \Omega$		18		ns
Rise time	t _r	$V_{GS} = 10 V$		35		ns
Turn-off delay time	t _{d(off)}			200		ns
Fall time	t _f			60		ns
Thermal resistance (ch-c)	R _{th(ch-c)}				12.5	°C/W
Thermal resistance (ch-a)	R _{th(ch-a)}				125	°C/W

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.



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